

International **ICR** Rectifier

HFA08SD60S

Ultrafast, Soft Recovery Diode

Features

- Ultrafast Recovery Time
- Ultrasoft Recovery
- Very Low I_{RRM}
- Very Low Q_{rr}
- Guaranteed Avalanche
- Specified at Operating Temperature

$t_{rr} = 18\text{ns}$
 $I_{F(AV)} = 8\text{Amp}$
 $V_R = 600\text{V}$

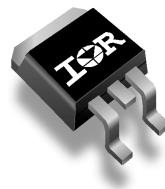
Benefits

- Reduced RFI and EMI
- Reduced Power Loss in Diode and Switching Transistor
- Higher Frequency Operation
- Reduced Snubbing
- Reduced Parts Count

Description/ Applications

These diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for freewheeling, flyback, power converters, motor drives, and other applications where high speed and reduced switching losses are design requirements.

Package Outline



D - PAK

Absolute Maximum Ratings

Parameters	Max	Units
V_{RRM} Cathode-to-Anode Voltage	600	V
$I_{F(AV)}$ Continuous Forward Current $T_C = 100^\circ\text{C}$	8	A
I_{FSM} Single Pulse Forward Current	60	
I_{FRM} Peak Repetitive Forward Current	24	
P_D Maximum Power Dissipation $T_C = 100^\circ\text{C}$	14	W
T_J, T_{STG} Operating Junction and Storage Temperatures	- 55 to 150	°C

HFA08SD60S

Bulletin PD-20618 07/00

International
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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Parameters	Min	Typ	Max	Units	Test Conditions
V_{BR}, V_r Breakdown Voltage, Blocking Voltage	600	-	-	V	$I_R = 100\mu\text{A}$
V_F Forward Voltage See Fig. 1	-	1.4	1.7	V	$I_F = 8\text{A}$
	-	1.7	2.1	V	$I_F = 16\text{A}$
	-	1.4	1.7	V	$I_F = 8\text{A}, T_J = 125^\circ\text{C}$
I_R Max. Reverse Leakage Current	-	0.3	5.0	μA	$V_R = V_R \text{ Rated}$
	-	100	500	μA	$T_J = 125^\circ\text{C}, V_R = 0.8 \times V_R \text{ Rated}$
C_T Junction Capacitance	-	10	25	pF	$V_R = 200\text{V}$
L_S Series Inductance	-	8.0	-	nH	Measured lead to lead 5mm from package body

Dynamic Recovery Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Parameters	Min	Typ	Max	Units	Test Conditions
t_{rr} Reverse Recovery Time	-	18	-	ns	$I_F = 1.0\text{A}, di_F/dt = 200\text{A}/\mu\text{A}, V_R = 30\text{V}$
	-	37	55		$T_J = 25^\circ\text{C}$
	-	55	90		$T_J = 125^\circ\text{C}$
I_{RRM} Peak Recovery Current	-	3.5	5.0	A	$T_J = 25^\circ\text{C}$
	-	4.5	8.0		$T_J = 125^\circ\text{C}$
Q_{rr} Reverse Recovery Charge	-	65	138	nC	$T_J = 25^\circ\text{C}$
	-	124	360		$T_J = 125^\circ\text{C}$
$di(\text{rec})/dt$ Rate of Fall of recovery Current	-	240	-	A/ μs	$T_J = 25^\circ\text{C}$
	-	210	-		$T_J = 125^\circ\text{C}$

Thermal - Mechanical Characteristics

Parameters	Min	Typ	Max	Units
T_J Max. Junction Temperature Range	-	-	- 55 to 150	°C
T_{Stg} Max. Storage Temperature Range	-	-	- 55 to 150	
T_{lead} Lead Temperature	-	-	300	
R_{thJC} Thermal Resistance, Junction to Case	-	-	3.5	°C/W
R_{thJA} ① Thermal Resistance, Junction to Ambient	-	-	80	
Wt Weight	-	2.0	-	g
	-	0.07	-	(oz)

① Typical Socket Mount

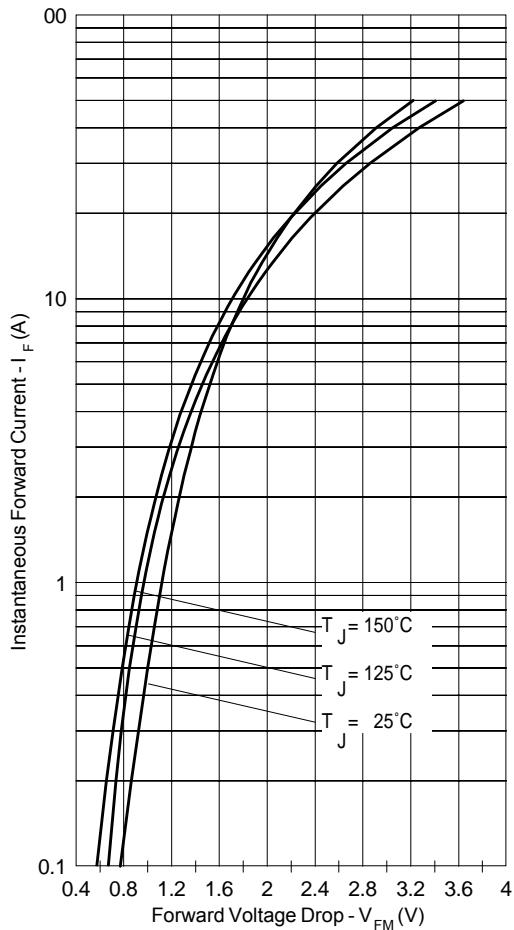


Fig.1 - Typical Forward Voltage Drop Characteristics

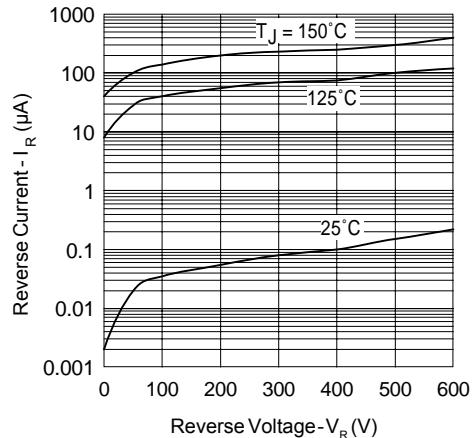


Fig.2 - Typical Values Of Reverse Current Vs. Reverse Voltage

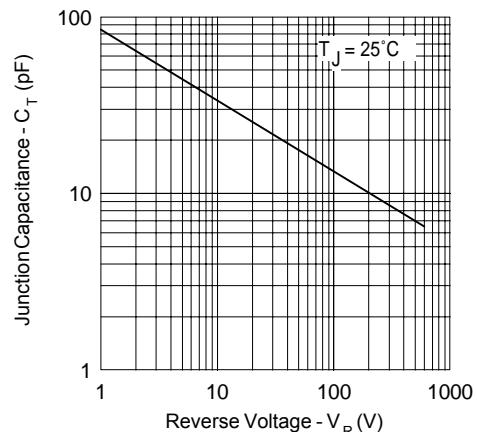


Fig.3 - Typical Junction Capacitance Vs. Reverse Voltage

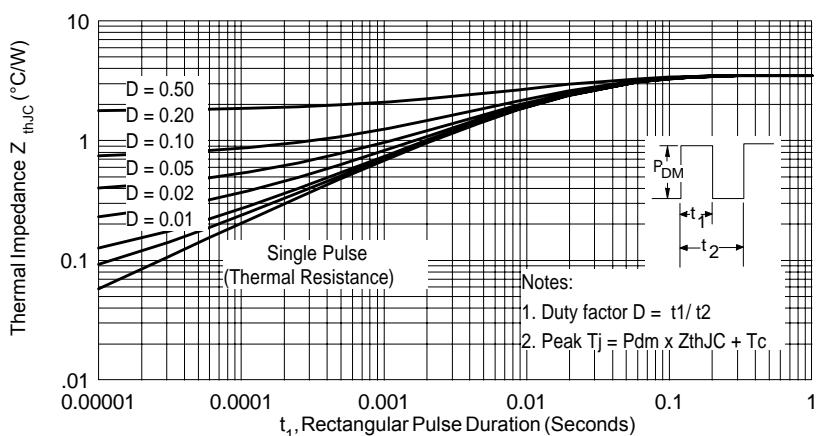


Fig.4 - Max. Thermal Impedance Z_{thJC} Characteristics

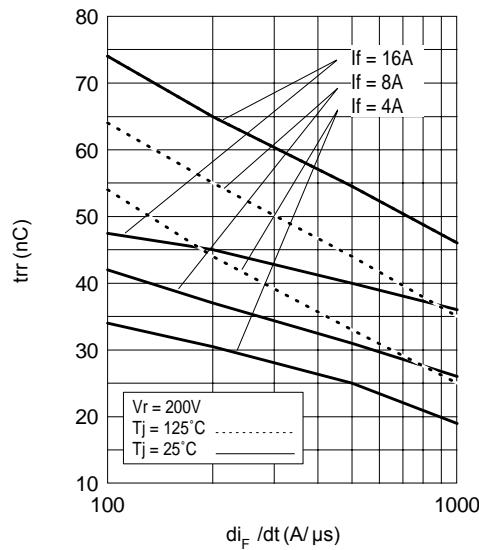


Fig. 5 - Typical Reverse Recovery vs. di_F/dt

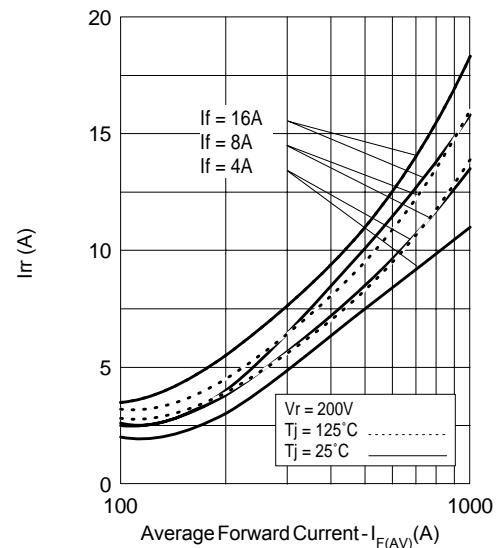


Fig. 6 - Typical Recovery Current vs. di_F/dt

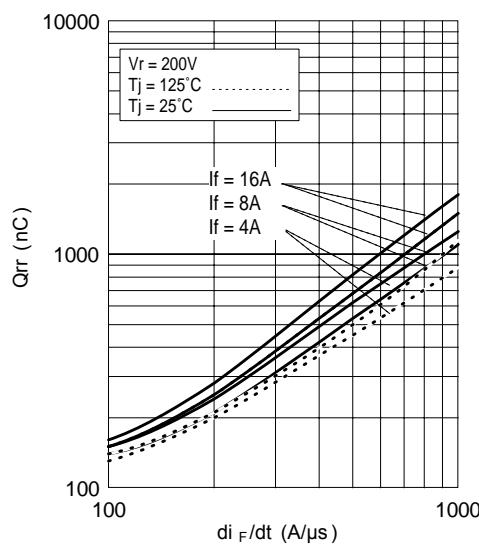


Fig. 7 - Typical Stored Charge vs. di_F/dt

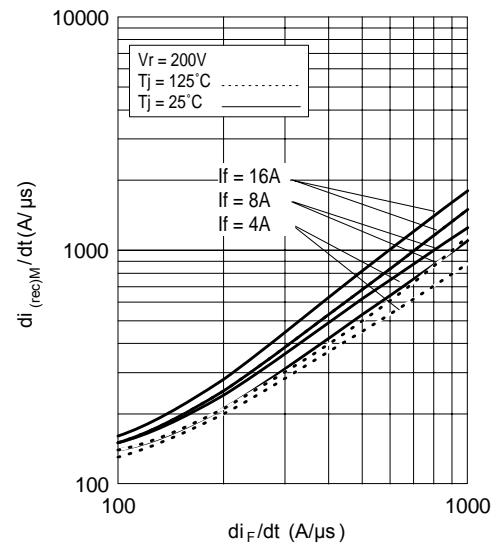


Fig. 8 - Typical $di_{(rec)M}/dt$ vs. di_F/dt

Reverse Recovery Circuit

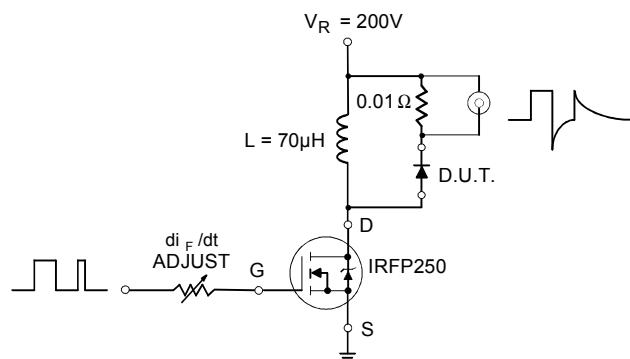
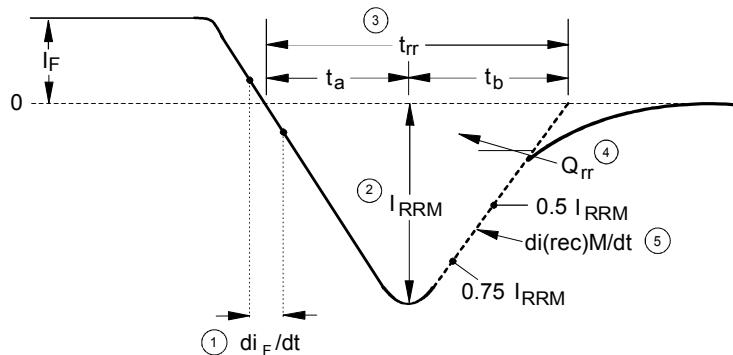


Fig. 9- Reverse Recovery Parameter Test Circuit



1. di_F/dt - Rate of change of current through zero crossing

4. Q_{rr} - Area under curve defined by t_{rr} and I_{RRM}

2. I_{RRM} - Peak reverse recovery current

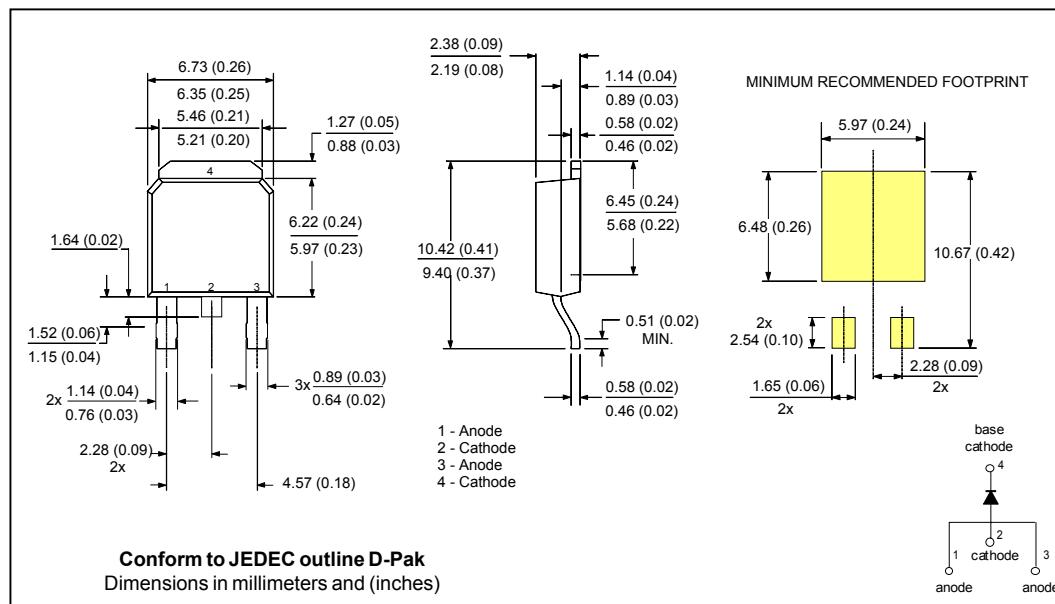
$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

3. t_{rr} - Reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current

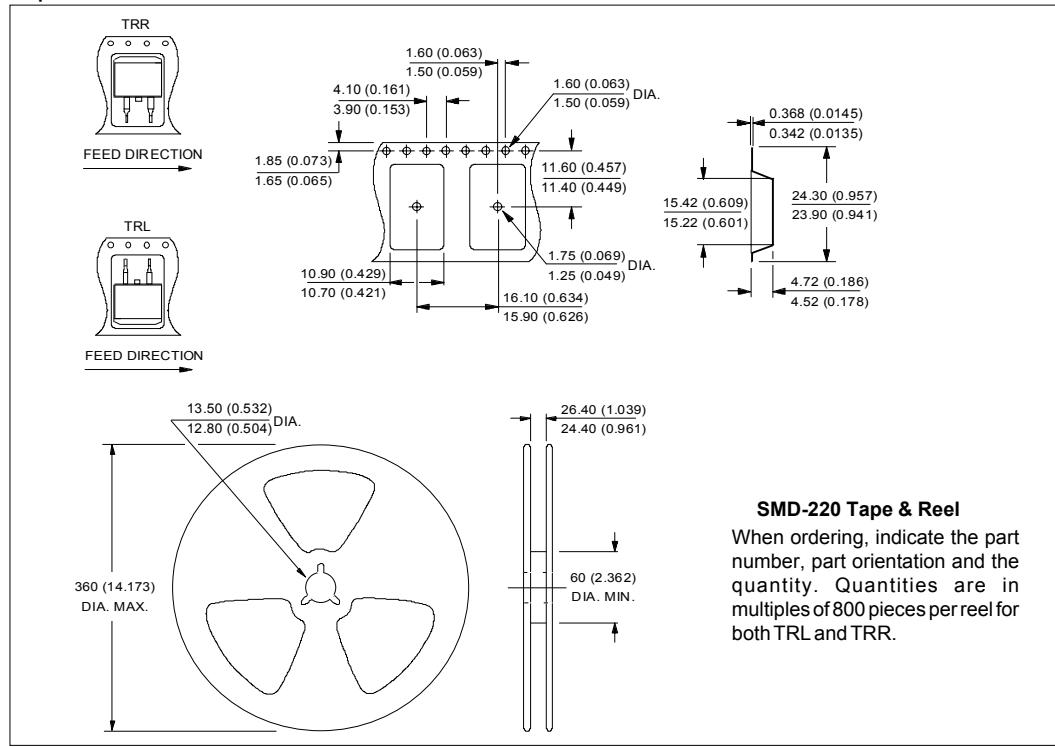
5. $di(rec)M/dt$ - Peak rate of change of current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions

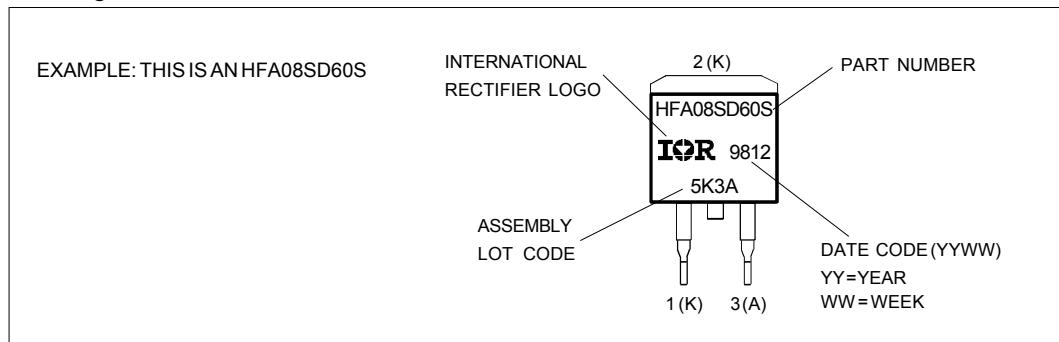
Outline Table



Tape & Reel Information



Marking Information



Ordering Information Table

Device Code					
	HF	A	08	SD	60
1	(1)	2	(2)	3	(3)
4	(4)	5	(5)	6	(6)
1	- Hexfred Family	2	- Electron Irradiated	3	- Current Rating (08 = 8A)
4	- D-PAK	5	- Voltage Rating (60 = 600V)	6	- Suffix
				S = D ² PAK/ Dpak TR = Tape & Reel TRL = Tape & Reel Left TRR = Tape & Reel Right	

International
IR Rectifier

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